



X5001

CPU Supervisor

Features

- 200ms Power On Reset Delay
- Low Vcc Detection and Reset Assertion
 - Five Standard Reset Threshold Voltages
 - Adjust Low Vcc Reset Threshold Voltage using special programming sequence
 - Reset Signal Valid to Vcc=1V
- Selectable Nonvolatile Watchdog Timer
 - 0.2, 0.6, 1.4 seconds
 - Off selection
 - Select settings through software
- Long Battery Life With Low Power Consumption
 - <50 μ A Max Standby Current, Watchdog On
 - <1 μ A Max Standby Current, Watchdog Off
- 1.8V to 5.5V Operation
- SPI Mode 0 interface
- Built-in Inadvertent Write Protection
 - Power-Up/Power-Down Protection Circuitry
 - Watchdog Change Latch
- High Reliability
- Available Packages
 - 8-Lead TSSOP
 - 8-Lead SOIC
 - 8 Pin PDIP

DESCRIPTION

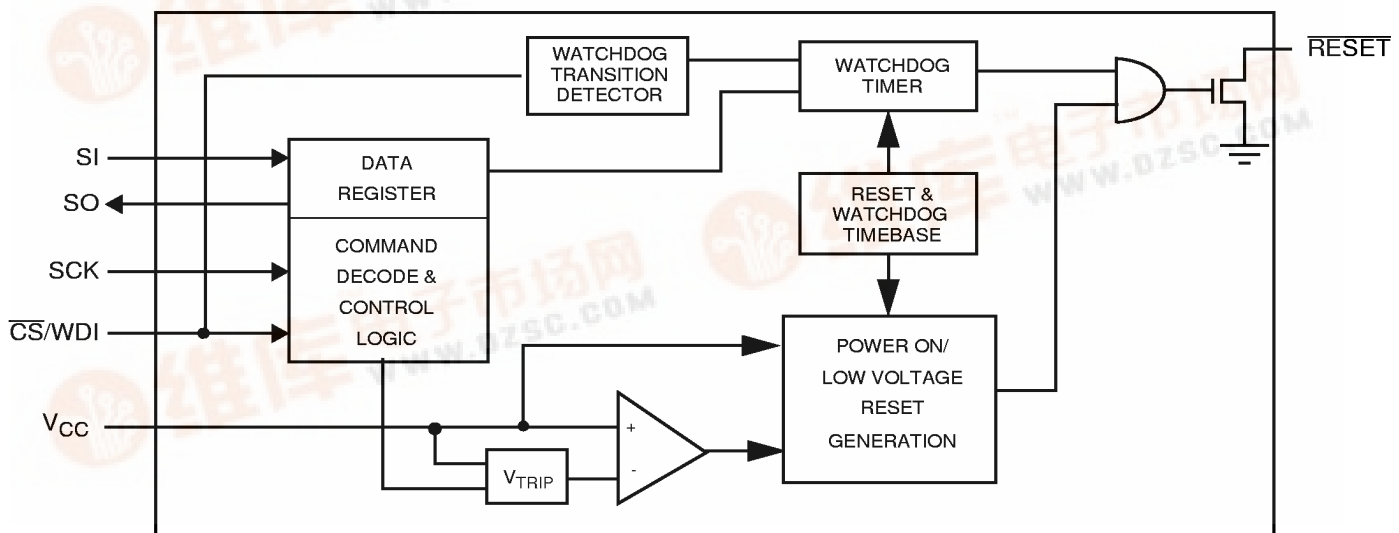
This device combines three popular functions, Power on Reset, Watchdog Timer, and Supply Voltage Supervision in one package. This combination lowers system cost, reduces board space requirements, and increases reliability.

The Watchdog Timer provides an independent protection mechanism for microcontrollers. During a system failure, the device will respond with a $\overline{\text{RESET}}$ signal after a selectable time-out interval. The user selects the interval from three preset values. Once selected, the interval does not change, even after cycling the power.

The user's system is protected from low voltage conditions by the device's low Vcc detection circuitry. When Vcc falls below the minimum Vcc trip point, the system is reset. $\overline{\text{RESET}}$ is asserted until Vcc returns to proper operating levels and stabilizes. Five industry standard V_{TRIP} thresholds are available, however, Xicor's unique circuits allow the threshold to be reprogrammed to meet custom requirements or to fine-tune the threshold for applications requiring higher precision.

The device utilizes Xicor's proprietary Direct Write™ cell for the Watchdog Timer control bits and the V_{TRIP} storage element, providing a minimum endurance of 100,000 write cycles and a minimum data retention of 100 years.

Block Diagram

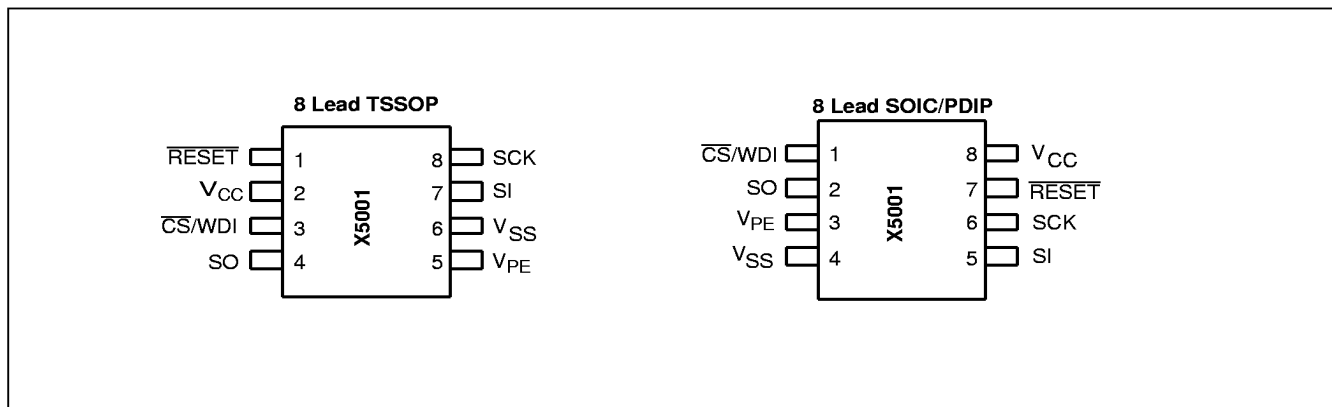


X5001

PIN DESCRIPTION

PIN (SOIC/PDIP)	PIN TSSOP	Name	Function
1	1	$\overline{\text{CS}}/\text{WDI}$	Chip Select Input. $\overline{\text{CS}}$ HIGH, deselects the device and the SO output pin is at a high impedance state. Unless a nonvolatile write cycle is underway, the device will be in the standby power mode. $\overline{\text{CS}}$ LOW enables the device, placing it in the active power mode. Prior to the start of any operation after power up, a HIGH to LOW transition on $\overline{\text{CS}}$ is required Watchdog Input. A HIGH to LOW transition on the WDI pin restarts the Watchdog timer. The absence of a HIGH to LOW transition within the watchdog time-out period results in $\overline{\text{RESET}}/\text{RESET}$ going active.
2	2	SO	Serial Output. SO is a push/pull serial data output pin. A read cycle shifts data out on this pin. The falling edge of the serial clock (SCK) clocks the data out.
5	8	SI	Serial Input. SI is a serial data input pin. Input all opcodes, byte addresses, and memory data on this pin. The rising edge of the serial clock (SCK) latches the input data. Send all opcodes (Table 1), addresses and data MSB first.
6	9	SCK	Serial Clock. The Serial Clock controls the serial bus timing for data input and output. The rising edge of SCK latches in the opcode, address, or watchdog bits present on the SI pin. The falling edge of SCK changes the data output on the SO pin.
3	6	V_{PE}	V_{TRIP} Program Enable. When V_{PE} is LOW, the V_{TRIP} point is fixed at the last valid programmed level. To readjust the V_{TRIP} level, requires that the VPE pin be pulled to a high voltage (15-18V).
4	7	V_{SS}	Ground
8	14	V_{CC}	Supply Voltage
7	13	$\overline{\text{RESET}}$	Reset Output. $\overline{\text{RESET}}$ is an active LOW, open drain output which goes active whenever V_{CC} falls below the minimum V_{CC} sense level. It will remain active until V_{CC} rises above the minimum V_{CC} sense level for 200ms. $\overline{\text{RESET}}$ goes active if the Watchdog Timer is enabled and $\overline{\text{CS}}/\text{WDI}$ remains either HIGH or LOW longer than the selectable Watchdog time-out period. A falling edge of $\overline{\text{CS}}/\text{WDI}$ will reset the Watchdog Timer. $\overline{\text{RESET}}$ goes active on power up at 1V and remains active for 200ms after the power supply stabilizes.
	3-5,10-12	NC	No internal connections

Figure 1. PIN CONFIGURATION



X5001

PRINCIPLES OF OPERATION

Power On Reset

Application of power to the X5001 activates a Power On Reset Circuit. This circuit goes active at 1V and pulls the $\overline{\text{RESET}}$ /RESET pin active. This signal prevents the system microprocessor from starting to operate with insufficient voltage or prior to stabilization of the oscillator. When V_{CC} exceeds the device V_{TRIP} value for 200ms (nominal) the circuit releases $\overline{\text{RESET}}$, allowing the processor to begin executing code.

Low voltage monitoring

During operation, the X5001 monitors the V_{CC} level and asserts $\overline{\text{RESET}}$ if supply voltage falls below a preset minimum V_{TRIP} . The $\overline{\text{RESET}}$ signal prevents the microprocessor from operating in a power fail or brownout condition. The $\overline{\text{RESET}}$ signal remains active until the voltage drops below 1V. It also remains active until V_{CC} returns and exceeds V_{TRIP} for 200ms.

Watchdog timer

The Watchdog Timer circuit monitors the microprocessor activity by monitoring the WDI input. The microprocessor must toggle the $\overline{\text{CS}}$ /WDI pin periodically to prevent a $\overline{\text{RESET}}$ signal. The $\overline{\text{CS}}$ /WDI pin must be toggled from HIGH to LOW prior to the expiration of the watchdog timeout period. The state of two nonvolatile control bits in the Watchdog Register determine the watchdog timer period.

Vcc Threshold Reset Procedure

The X5001 is shipped with a standard V_{CC} threshold (V_{TRIP}) voltage. This value will not change over normal operating and storage conditions. However, in applications where the standard V_{TRIP} is not exactly right, or if higher precision is needed in the V_{TRIP} value, the X5001 threshold may be adjusted. The procedure is described below, and requires the application of a high voltage control signal.

Setting the V_{TRIP} Voltage

This procedure is used to set the V_{TRIP} to a higher voltage value. For example, if the current V_{TRIP} is 4.4V and the new V_{TRIP} is 4.6V, this procedure will directly make the change. If the new setting is to be lower than the current setting, then it is necessary to reset the trip point before setting the new value.

To set the new V_{TRIP} voltage, apply the desired V_{TRIP} threshold voltage to the V_{CC} pin and tie the W_{PE} pin to the programming voltage V_P . Then a V_{TRIP} programming command sequence is sent to the device over the SPI interface. This V_{TRIP} programming sequence consists of pulling $\overline{\text{CS}}$ LOW, then clocking in data 06h. This is followed by bringing $\overline{\text{CS}}$ HIGH then LOW and clocking in data 02h, 00h, 01h, and 00h (in order) and bringing $\overline{\text{CS}}$ HIGH. This initiates the V_{TRIP} programming sequence. V_P is brought LOW to end the operation.

Resetting the V_{TRIP} Voltage

This procedure is used to set the V_{TRIP} to a “native” voltage level. For example, if the current V_{TRIP} is 4.4V and the new V_{TRIP} must be 4.0V, then the V_{TRIP} must be reset. When V_{TRIP} is reset, the new V_{TRIP} is something less than 1.7V. This procedure must be used to set the voltage to a lower value.

To reset the V_{TRIP} voltage, apply greater than 3V to the V_{CC} pin and tie the W_{PE} pin to the programming voltage V_P . Then a V_{TRIP} command sequence is sent to the device over the SPI interface. This V_{TRIP} programming sequence consists of pulling $\overline{\text{CS}}$ LOW, then clocking in data 06h. This is followed by bringing $\overline{\text{CS}}$ HIGH then LOW and clocking in data 02h, 00h, 03h, and 00h (in order) and bringing $\overline{\text{CS}}$ HIGH. This initiates the V_{TRIP} programming sequence. V_P is brought LOW to end the operation.

X5001

Figure 2. Sample V_{TRIP} Reset Circuit

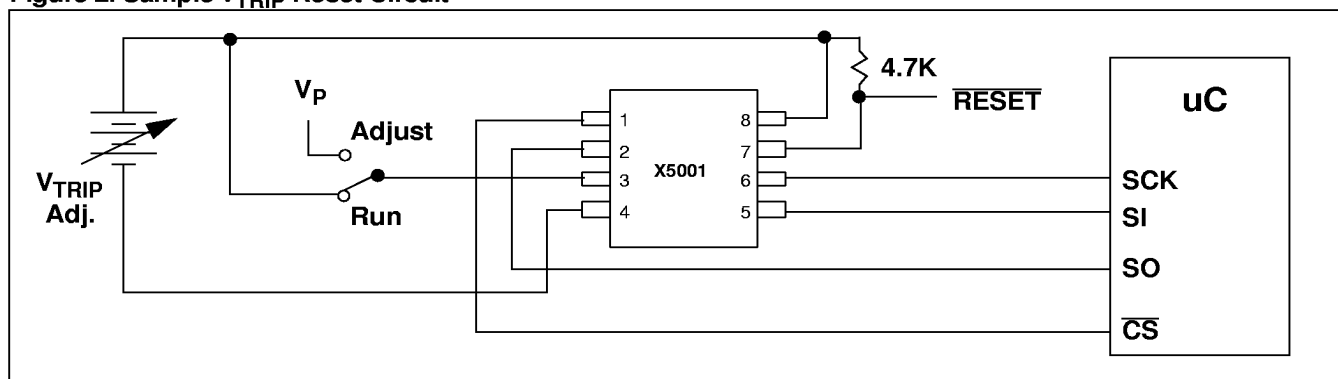


Figure 3. Set V_{TRIP} Level Sequence (V_{CC} =desired V_{TRIP} value.)

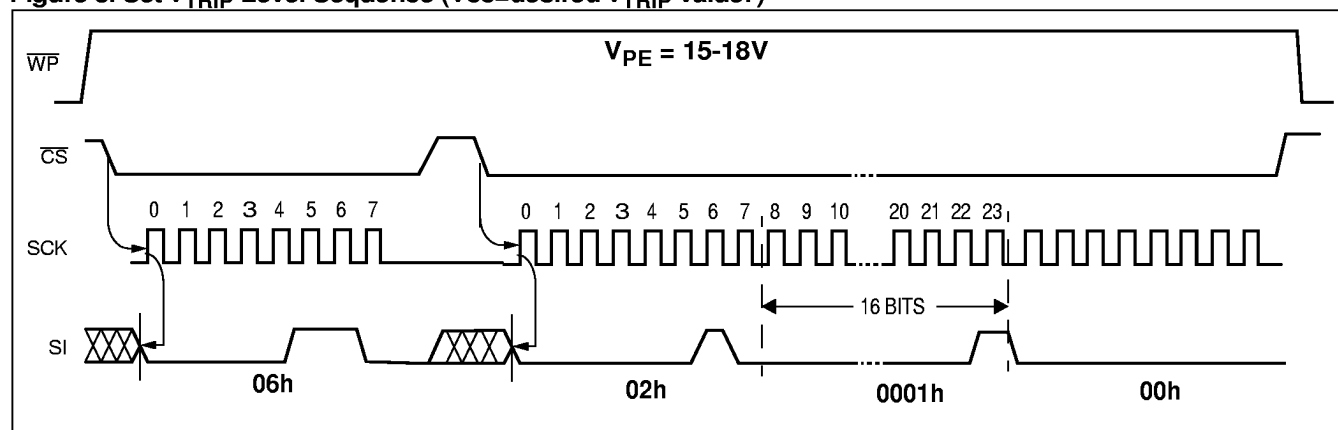


Figure 4. Reset V_{TRIP} Level Sequence ($V_{CC} > 3V$.)

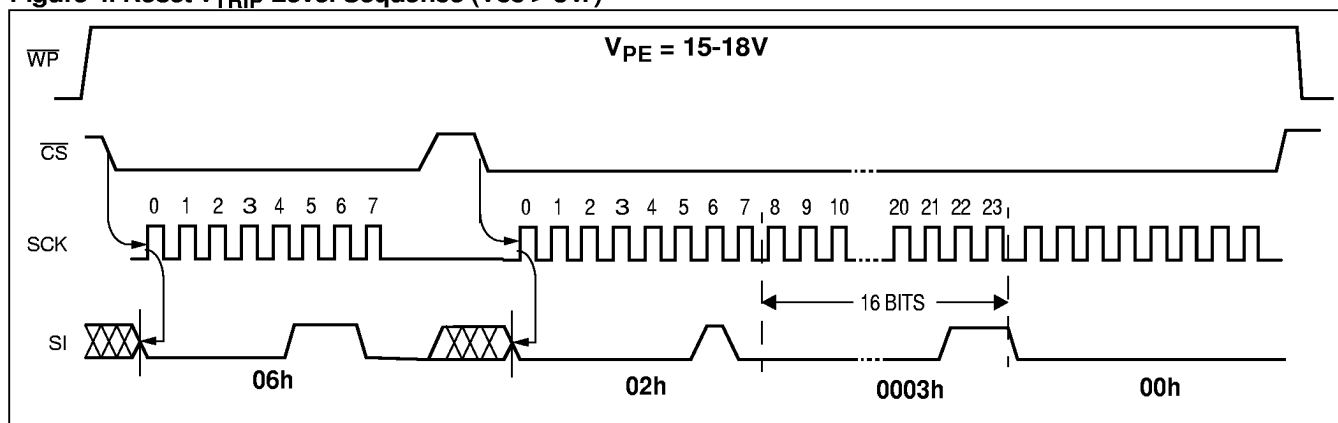
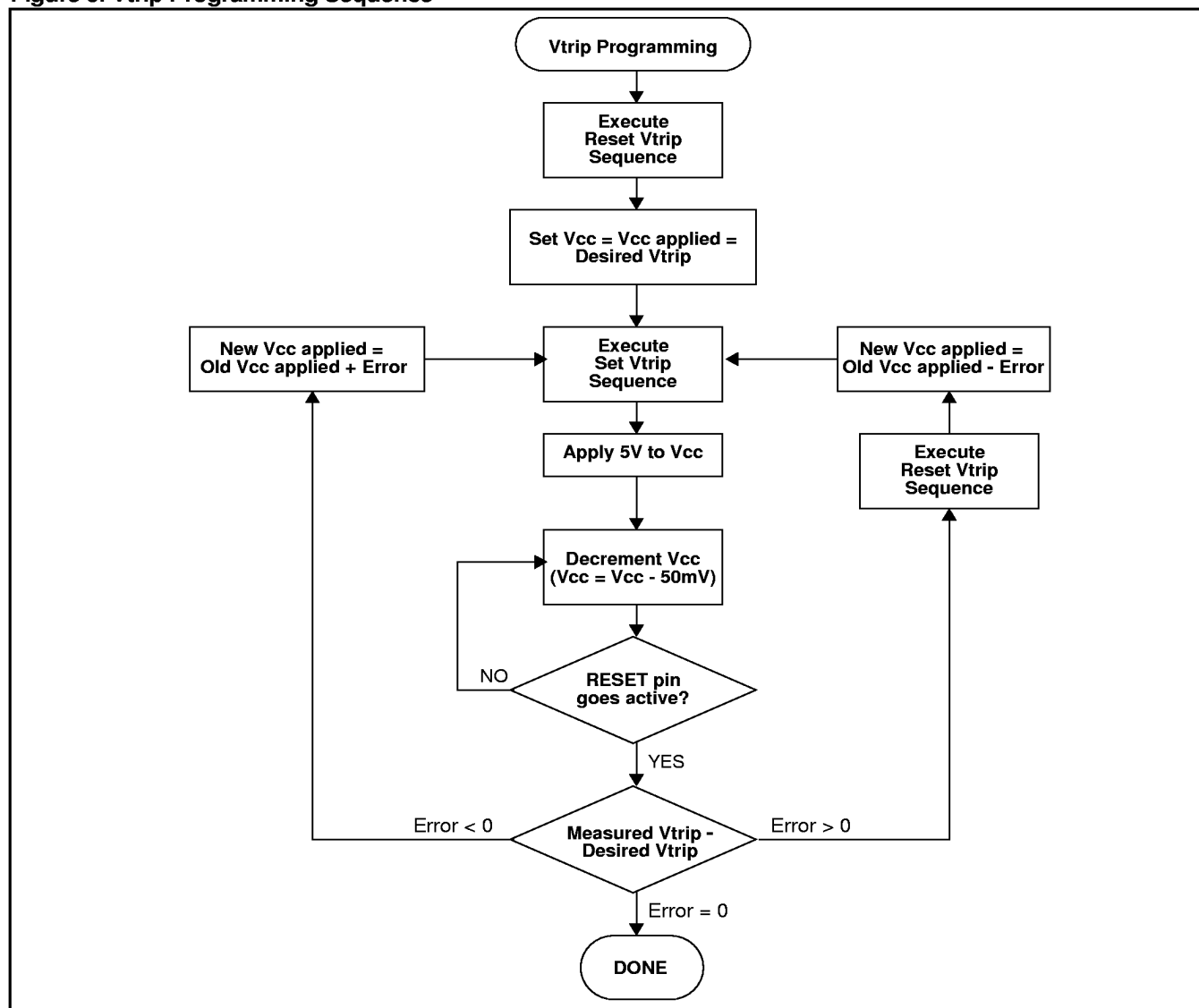


Figure 5. Vtrip Programming Sequence



X5001

SPI Interface

The device is designed to interface directly with the synchronous Serial Peripheral Interface (SPI) of many popular microcontroller families.

The device monitors the \overline{CS}/WDI line and asserts \overline{RESET} output if there is no activity within user selectable time-out period. The device also monitors the V_{CC} supply and asserts the \overline{RESET} if V_{CC} falls below a preset minimum (V_{TRIP}). The device contains an 8-bit Watchdog Timer Register to control the watchdog time-out period. The current settings are accessed via the SI and SO pins.

All instructions (Table 1) and data are transferred MSB first. Data input on the SI line is latched on the first rising edge of SCK after \overline{CS} goes LOW. Data is output on the SO line by the falling edge of SCK. SCK is static, allowing the user to stop the clock and then start it again to resume operations where left off.

Watchdog Timer Register

7	6	5	4	3	2	1	0
0	0	0	WD ₁	WD ₀	0	0	0

Watchdog Timer Control Bits

The Watchdog Timer Control bits, WD₀ and WD₁, select the Watchdog Time-out Period. These nonvolatile bits are programmed with the Set Watchdog Timer (SWDT) instruction.

Watchdog Control Bits		Watchdog Time-out (Typical)
WD1	WD0	
0	0	1.4 Seconds
0	1	600 Milliseconds
1	0	200 Milliseconds
1	1	Disabled

Write Watchdog Register Operation

Changing the Watchdog Timer Register is a two step process. First, the change must be enabled with by setting the Watchdog Change Latch (see below). This instruction is followed by the Set Watchdog Timer (SWDT) instruction, which includes the data to be written (Figure 5). Data bits 3 and 4 contain the Watchdog settings and data bits 0, 1, 2, 5, 6 and 7 must be "0".

Watchdog Change Latch

The Watchdog Change Latch must be SET before a Write Watchdog Timer Operation is initiated. The Enable Watchdog Change (EWDC) instruction will set the latch and the Disable Watchdog Change (DWDC) instruction will reset the latch (See) This latch is automatically reset upon a power-up condition and after the completion of a valid nonvolatile write cycle.

Read Watchdog Timer Register Operation

If there is not a nonvolatile write in progress, the Read Watchdog Timer instruction returns the setting of the watchdog timer control bits. The other bits are reserved and will return '0' when read. See Figure 3.

If a nonvolatile write is in progress, the Read Watchdog Timer Register Instruction returns a HIGH on SO. When the nonvolatile write cycle is completed, a separate Read Watchdog Timer instruction should be used to determine the current status of the Watchdog control bits.

RESET Operation

The \overline{RESET} (X5001) output is designed to go LOW whenever V_{CC} has dropped below the minimum trip point and/or the Watchdog timer has reached its programmable time-out limit.

The \overline{RESET} output is an open drain output and requires a pull up resistor.

Operational Notes

The device powers-up in the following state:

- The device is in the low power standby state.
- A HIGH to LOW transition on \overline{CS} is required to enter an active state and receive an instruction.
- SO pin is high impedance.
- The Watchdog Change Latch is reset.
- The \overline{RESET} Signal is active for t_{PURST} .

Data Protection

The following circuitry has been included to prevent inadvertent writes:

- A EWDC instruction must be issued to enable a change to the watchdog timeout setting.
- \overline{CS} must come HIGH at the proper clock count in order to implement the requested changes to the watchdog timeout setting.

Table 1. Instruction Set Definition

Instruction Format	Instruction Name and Operation
0000 0110	EWDC: Enable Watchdog Change Operation
0000 0100	DWDC: Disable Watchdog Change Operation
0000 0001	SWDT: Set Watchdog Timer control bits: Instruction followed by contents of register: 000(WD ₁) (WD ₀)000 See Watchdog Timer Settings and
0000 0101	RWDT: Read Watchdog Timer control bits

Notes: Instructions are shown with MSB in leftmost position. Instructions are transferred MSB first.

7038 FRMT03

Figure 6. Read Watchdog Timer setting

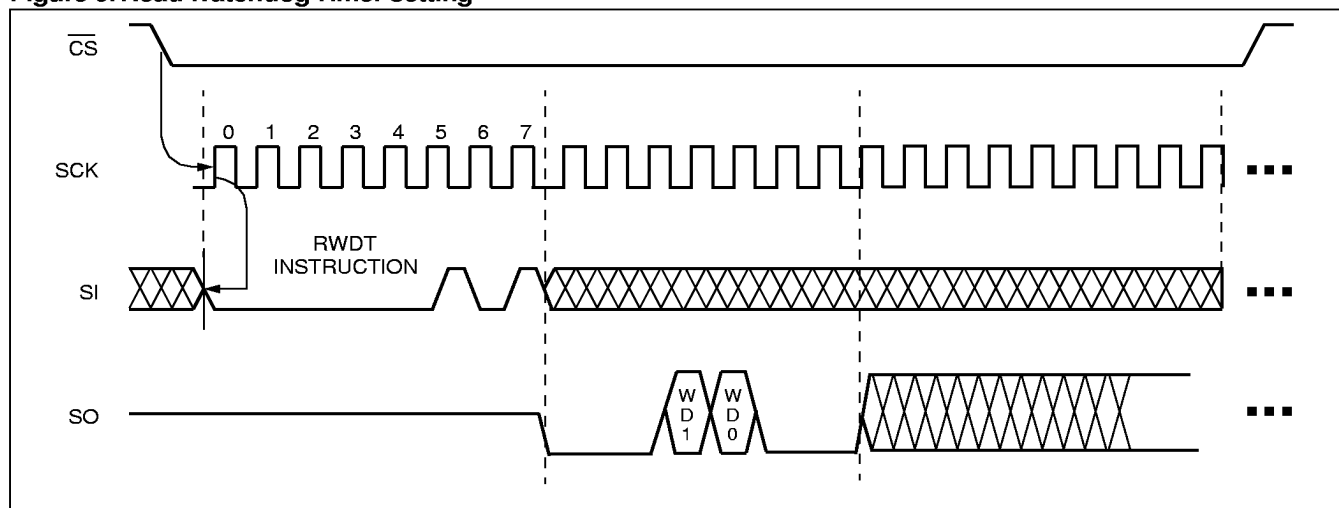


Figure 7. Enable Watchdog Change/Disable Watchdog Change Sequence

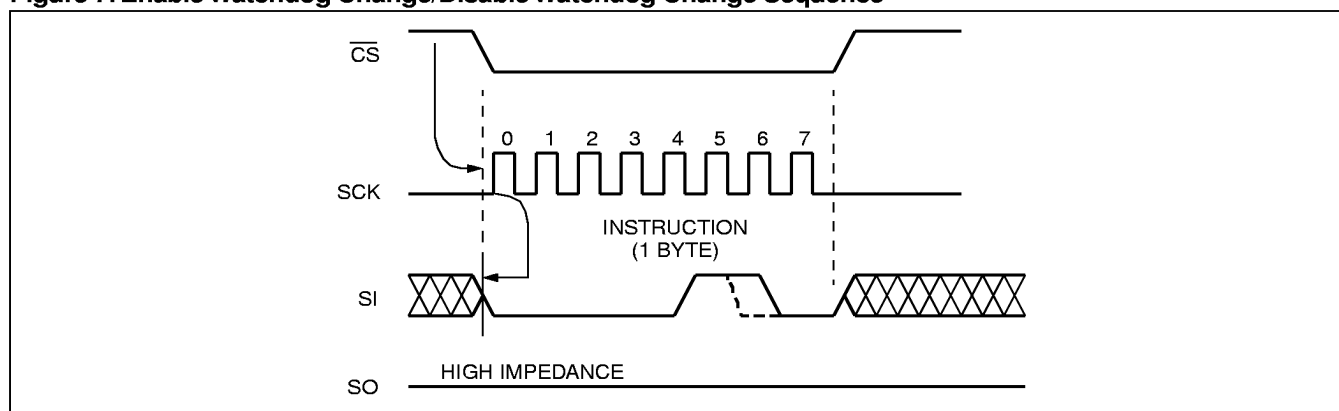


Figure 8. Write Watchdog Timer Sequence

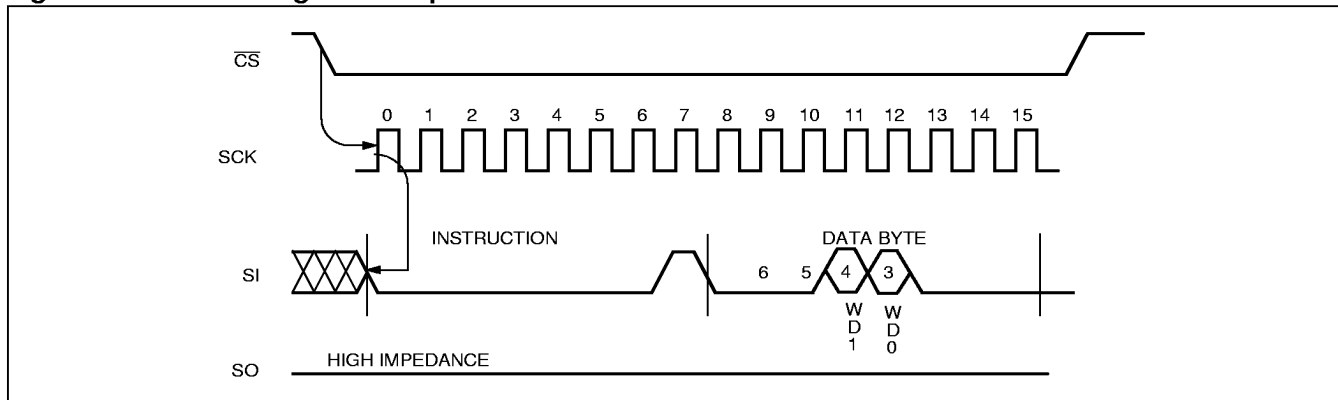


Figure 9. Read Nonvolatile Status (Option 1) (Used to determine end of Watchdog Timer store operation)

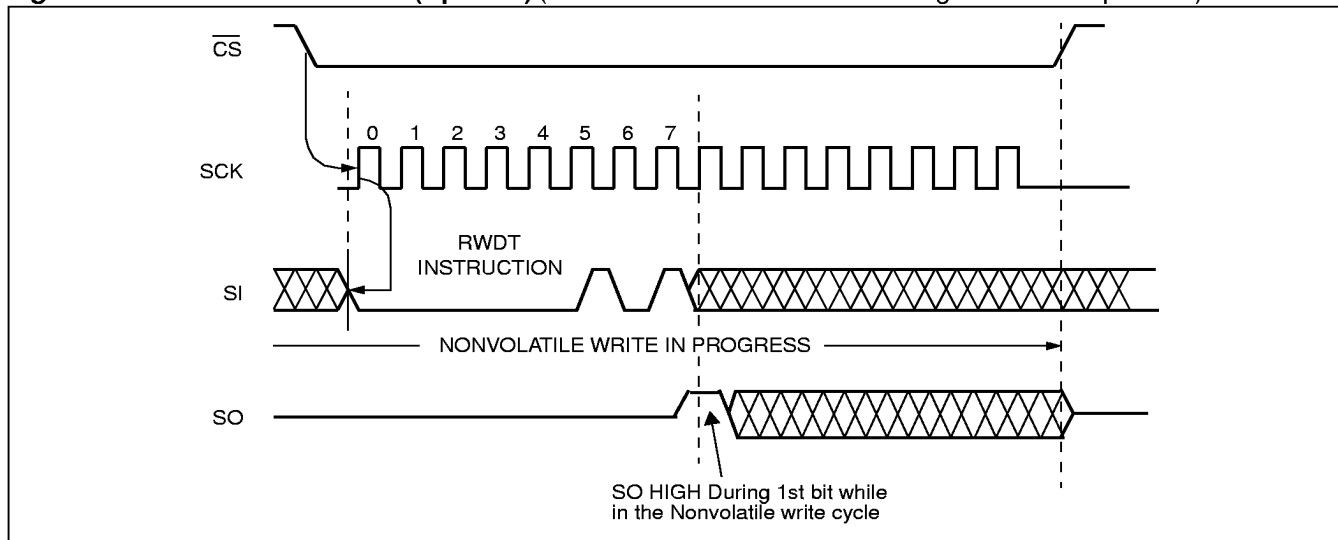
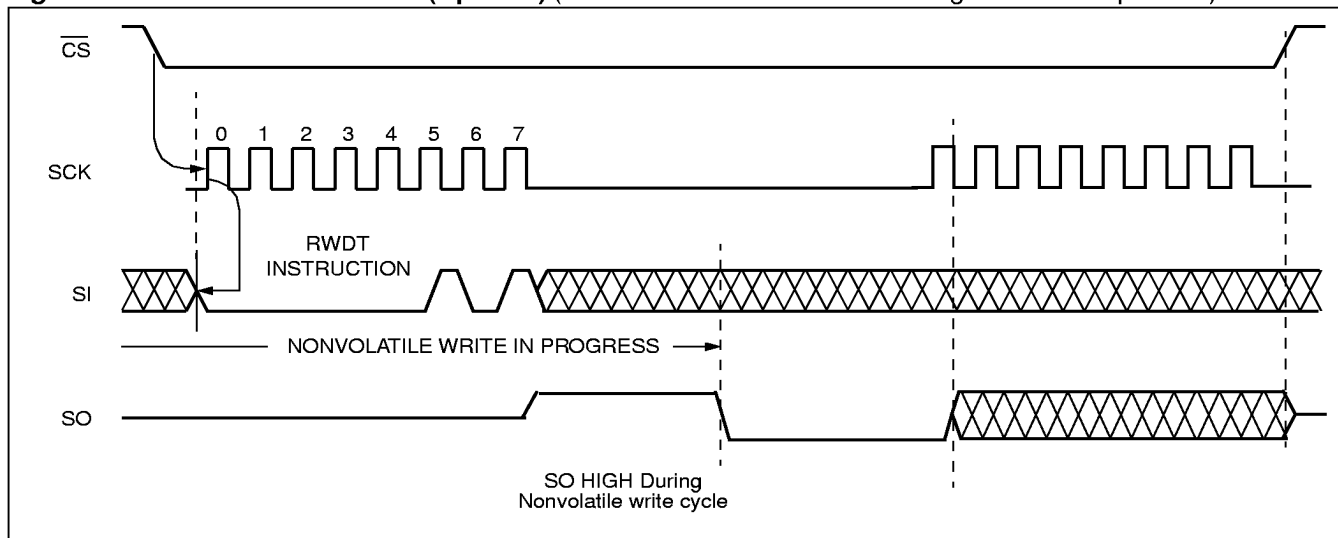


Figure 10. Read Nonvolatile Status (Option 2) (Used to determine end of Watchdog Timer store operation)



X5001

ABSOLUTE MAXIMUM RATINGS*

Temperature under Bias-65°C to +135°C
 Storage Temperature-65°C to +150°C
 Voltage on any Pin with Respect to V_{SS}-1.0V to +7V
 D.C. Output Current5mA
 Lead Temperature (Soldering, 10 seconds)..... 300°C

RECOMMENDED OPERATING CONDITIONS

Temp	Min.	Max.
Commercial	0°C	+70°C

7036 FRM T07

*COMMENT

Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and the functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Voltage Option	Supply Voltage Limits
-1.8	1.8V to 3.6V
-2.7 or -2.7A	2.7V to 5.5V
-4.5 or -4.5A	4.5V to 5.5V

PT= Package, Temperature

D.C. OPERATING CHARACTERISTICS (Over the recommended operating conditions unless otherwise specified.)

Symbol	Parameter	Limits			Units	Test Conditions
		Min.	Typ.	Max.		
I_{CC1}	V_{CC} Write Current (Active)			5	mA	$SCK = V_{CC} \times 0.1/V_{CC} \times 0.9$ @ 5MHz, SO = Open
I_{CC2}	V_{CC} Read Current (Active)			0.4	mA	$SCK = V_{CC} \times 0.1/V_{CC} \times 0.9$ @ 5MHz, SO = Open
I_{SB1}	V_{CC} Standby Current WDT=OFF			1	μA	$\overline{CS} = V_{CC}$, $V_{IN} = V_{SS}$ or V_{CC} , $V_{CC} = 5.5V$
I_{SB2}	V_{CC} Standby Current WDT=ON			50	μA	$\overline{CS} = V_{CC}$, $V_{IN} = V_{SS}$ or V_{CC} , $V_{CC} = 5.5V$
I_{SB3}	V_{CC} Standby Current WDT=ON			20	μA	$\overline{CS} = V_{CC}$, $V_{IN} = V_{SS}$ or V_{CC} , $V_{CC} = 3.6V$
I_{LI}	Input Leakage Current		0.1	10	μA	$V_{IN} = V_{SS}$ to V_{CC}
I_{LO}	Output Leakage Current		0.1	10	μA	$V_{OUT} = V_{SS}$ to V_{CC}
$V_{IL}^{(1)}$	Input LOW Voltage	-0.5		$V_{CC} \times 0.3$	V	
$V_{IH}^{(1)}$	Input HIGH Voltage	$V_{CC} \times 0.7$		$V_{CC} + 0.5$	V	
V_{OL1}	Output LOW Voltage			0.4	V	$V_{CC} > 3.3V$, $I_{OL} = 2.1mA$
V_{OL2}	Output LOW Voltage			0.4	V	$2V < V_{CC} < 3.3V$, $I_{OL} = 1mA$
V_{OL3}	Output LOW Voltage			0.4	V	$V_{CC} \leq 2V$, $I_{OL} = 0.5mA$
V_{OH1}	Output HIGH Voltage	$V_{CC} - 0.8$			V	$V_{CC} > 3.3V$, $I_{OH} = -1.0mA$
V_{OH2}	Output HIGH Voltage	$V_{CC} - 0.4$			V	$2V < V_{CC} \leq 3.3V$, $I_{OH} = -0.4mA$
V_{OH3}	Output HIGH Voltage	$V_{CC} - 0.2$			V	$V_{CC} \leq 2V$, $I_{OH} = -0.25mA$
V_{OLRS}	Reset Output LOW Voltage			0.4	V	$I_{OL} = 1mA$

POWER-UP TIMING

Symbol	Parameter	Min.	Max.	Units
$t_{PUR}^{(2)}$	Power-up to Read Operation		1	ms
$t_{PUW}^{(2)}$	Power-up to Write Operation		5	ms

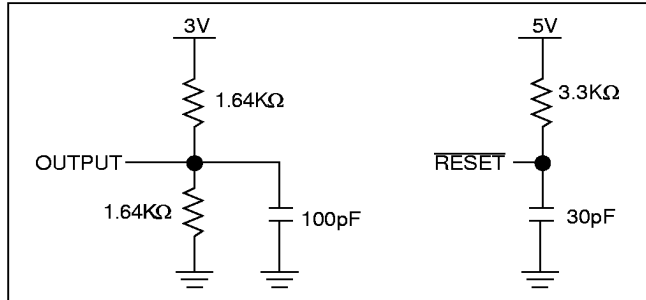
CAPACITANCE $T_A = +25^\circ C$, $f = 1MHz$, $V_{CC} = 5V$.

Symbol	Test	Max.	Units	Conditions
$C_{OUT}^{(2)}$	Output Capacitance (SO, RESET)	8	pF	$V_{OUT} = 0V$
$C_{IN}^{(2)}$	Input Capacitance (SCK, SI, \overline{CS})	6	pF	$V_{IN} = 0V$

Notes: (1) V_{IL} min. and V_{IH} max. are for reference only and are not tested.
 (2) This parameter is periodically sampled and not 100% tested.

X5001

Figure 1. EQUIVALENT A.C. LOAD CIRCUIT



A.C. TEST CONDITIONS

Input Pulse Levels	$V_{CC} \times 0.1$ to $V_{CC} \times 0.9$
Input Rise and Fall Times	10ns
Input and Output Timing Level	$V_{CC} \times 0.5$

A.C. CHARACTERISTICS (Over recommended operating conditions, unless otherwise specified)

Data Input Timing

Symbol	Parameter	1.8V–3.6V		2.7V–5.5V		Units
		Min.	Max.	Min.	Max.	
f_{SCK}	Clock Frequency	0	1	0	2	MHz
t_{CYC}	Cycle Time	1000		500		ns
t_{LEAD}	\overline{CS} Lead Time	400		200		ns
t_{LAG}	\overline{CS} Lag Time	400		200		ns
t_{WH}	Clock HIGH Time	400		200		ns
t_{WL}	Clock LOW Time	400		200		ns
t_{SU}	Data Setup Time	100		50		ns
t_H	Data Hold Time	100		50		ns
$t_{RI}^{(3)}$	Input Rise Time		2		2	μs
$t_{FI}^{(3)}$	Input Fall Time		2		2	μs
t_{CS}	\overline{CS} Deselect Time	250		150		ns
$t_{WC}^{(4)}$	Write Cycle Time		10		10	ms

Data Output Timing

Symbol	Parameter	1.8V–3.6V		2.7V–5.5V		Units
		Min.	Max.	Min.	Max.	
f_{SCK}	Clock Frequency	0	1	0	2	MHz
t_{DIS}	Output Disable Time		400		200	ns
t_V	Output Valid from Clock Low		400		200	ns
t_{HO}	Output Hold Time	0		0		ns
$t_{RO}^{(3)}$	Output Rise Time		300		150	ns
$t_{FO}^{(3)}$	Output Fall Time		300		150	ns

Notes: (3) This parameter is periodically sampled and not 100% tested.

(4) t_{WC} is the time from the rising edge of \overline{CS} after a valid write sequence has been sent to the end of the self-timed internal nonvolatile write cycle.

Figure 1. Data Output Timing

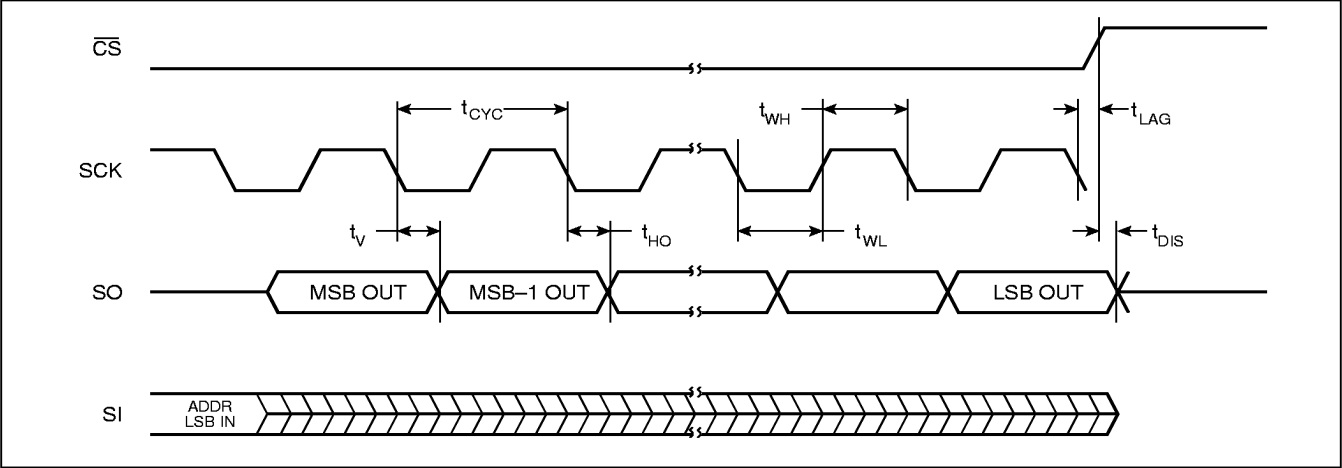


Figure 2. Data Input Timing

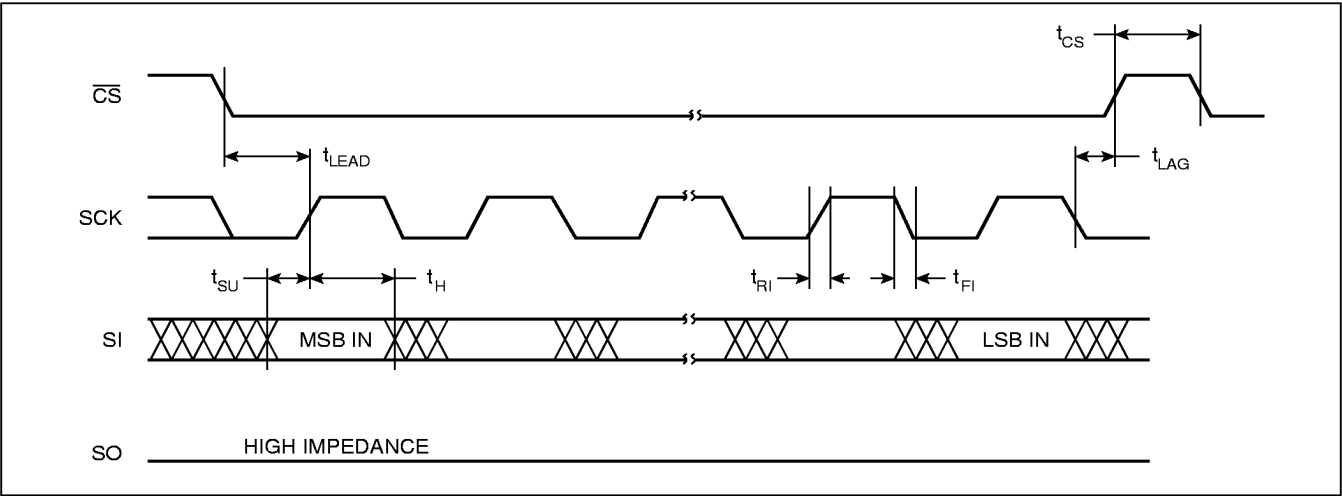
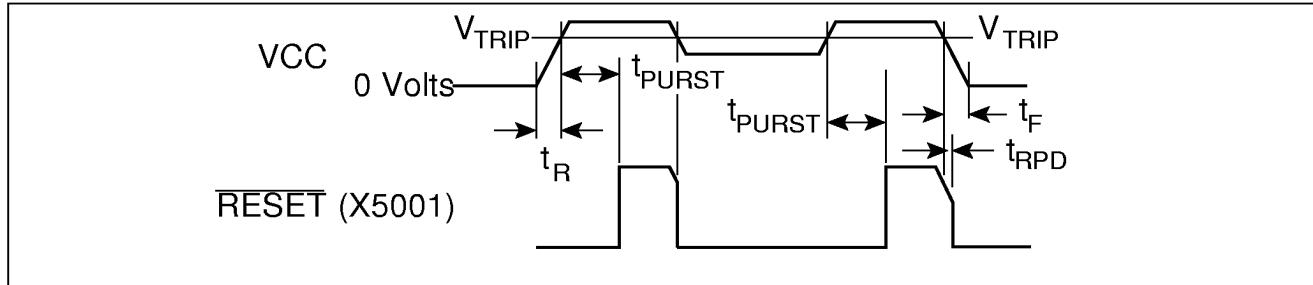


Figure 1. Symbol Table

WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Will be steady
	May change from LOW to HIGH	Will change from LOW to HIGH
	May change from HIGH to LOW	Will change from HIGH to LOW
	Don't Care: Changes Allowed	Changing: State Not Known
	N/A	Center Line is High Impedance

X5001

Figure 1. Power-Up and Power-Down Timing

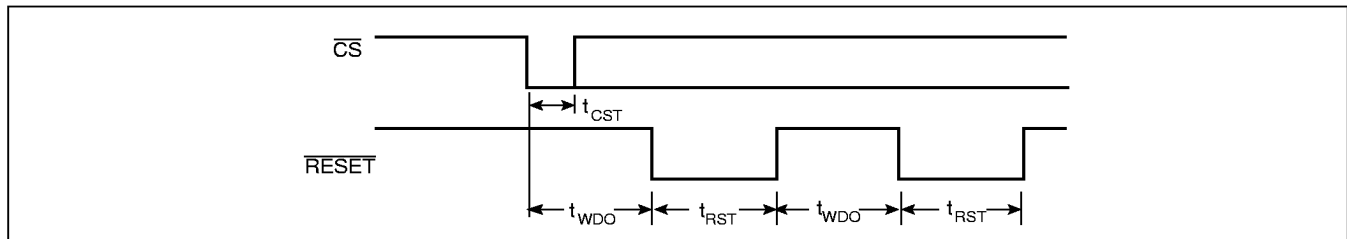


RESET Output Timing

Symbol	Parameter	Min.	Typ.	Max.	Units
V_{TRIP}	Reset Trip Point Voltage, X5001PT-4.5A	4.50	4.63	4.75	V
	Reset Trip Point Voltage, X5001PT-4.5	4.25	4.38	4.50	
	Reset Trip Point Voltage, X5001PT-2.7A	2.85	2.92	3.00	
	Reset Trip Point Voltage, X5001PT-2.7	2.55	2.63	2.70	
	Reset Trip Point Voltage, X5001PT-1.8	1.70	1.75	1.80	
t_{PURST}	Power-up Reset Timeout	100	200	280	ms
$t_{RPD}^{(5)}$	V_{CC} Detect to Reset/Output			500	ns
$t_F^{(5)}$	V_{CC} Fall Time	0.1			ns
$t_R^{(5)}$	V_{CC} Rise Time	0.1			ns
V_{RVALID}	Reset Valid V_{CC}	1			V

Notes: (5) This parameter is periodically sampled and not 100% tested.
PT = Package, Temperature

Figure 2. \overline{CS} vs. RESET Timing

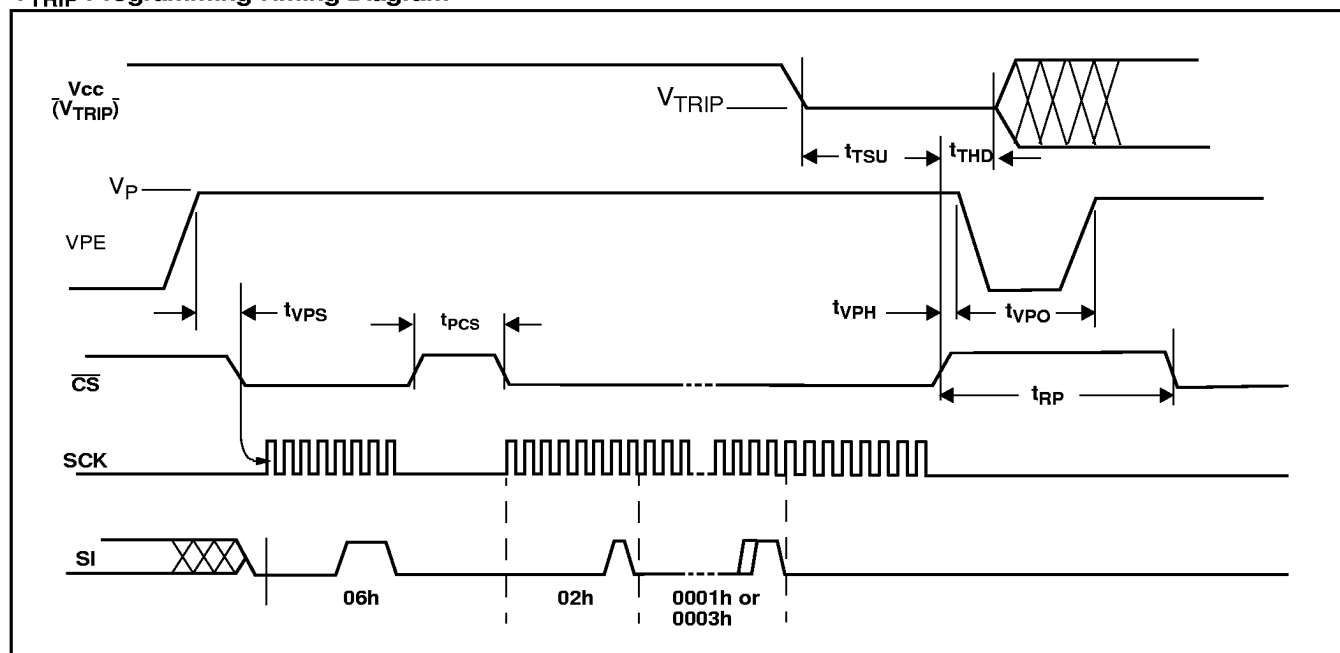


RESET Output Timing

Symbol	Parameter	Min.	Typ.	Max.	Units
t_{WDO}	Watchdog Timeout Period, $WD_1 = 1, WD_0 = 0$	100	200	300	ms
	$WD_1 = 0, WD_0 = 1$	450	600	800	ms
	$WD_1 = 0, WD_0 = 0$	1	1.4	2	sec
t_{CST}	\overline{CS} Pulse Width to Reset the Watchdog	400			ns
t_{RST}	Reset Timeout	100	200	300	ms

X5001

V_{TRIP} Programming Timing Diagram



X5001

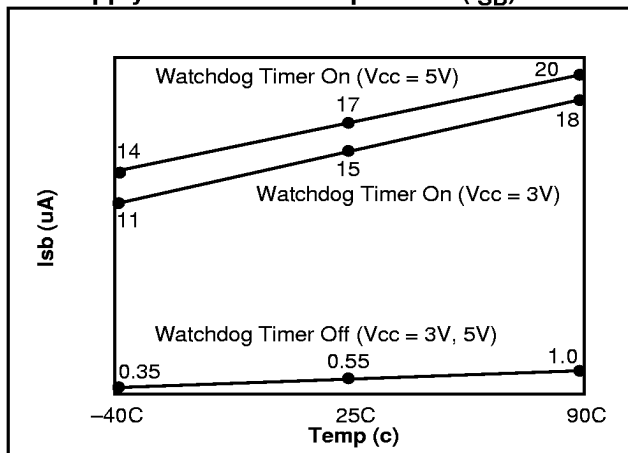
V_{TRIP} Programming Parameters

Parameter	Description	Min	Max	Units
t _{VPS}	V _{TRIP} Program Enable Voltage Setup time	1		μs
t _{VPH}	V _{TRIP} Program Enable Voltage Hold time	1		μs
t _{PCS}	V _{TRIP} Programming \overline{CS} inactive time	1		μs
t _{TSU}	V _{TRIP} Setup time	1		μs
t _{THD}	V _{TRIP} Hold (stable) time	10		ms
t _{WC}	V _{TRIP} Write Cycle Time		10	ms
t _{VPO}	V _{TRIP} Program Enable Voltage Off time (Between successive adjustments)	0		us
t _{RP}	V _{TRIP} Program Recovery Period (Between successive adjustments)	10		ms
V _P	Programming Voltage	15	18	V
V _{TRAN}	V _{TRIP} Programmed Voltage Range	1.7	5.0	V
V _{ta1}	Initial V _{TRIP} Program Voltage accuracy (V _{cc} applied - V _{TRIP}) (Programmed at 25°C.)	-0.1	+0.4	V
V _{ta2}	Subsequent V _{TRIP} Program Voltage accuracy [(V _{cc} applied - V _{ta1}) - V _{TRIP} Programmed at 25°C.]	-25	+25	mV
V _{tr}	V _{TRIP} Program Voltage repeatability (Successive program operations. Programmed at 25°C.)	-25	+25	mV
V _{tv}	V _{TRIP} Program variation after programming (0-75°C). (Programmed at 25°C.)	-25	+25	mV

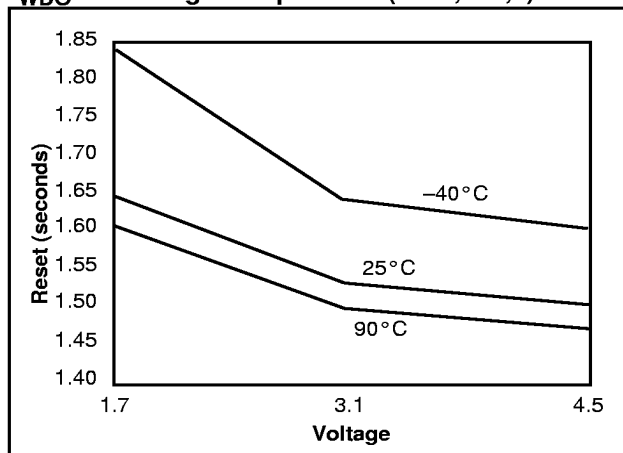
V_{TRIP} Programming parameters are periodically sampled and are not 100% Tested.

X5001

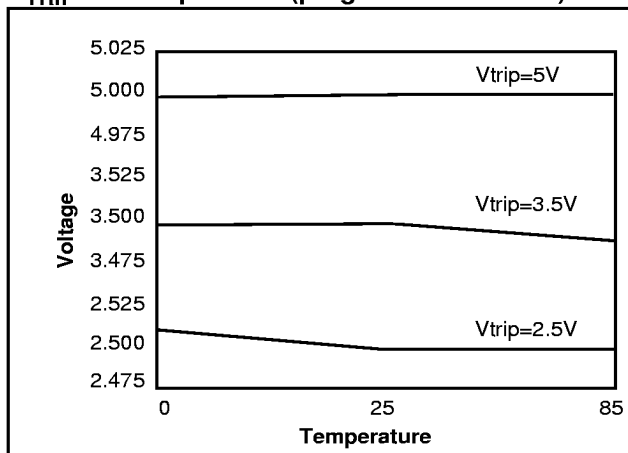
Vcc Supply Current vs. Temperature (I_{SB})



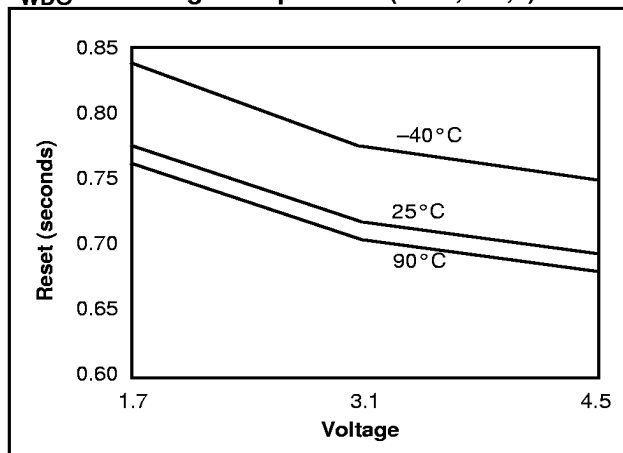
t_{WDO} vs. Voltage/Temperature (WD1,0=1,1)



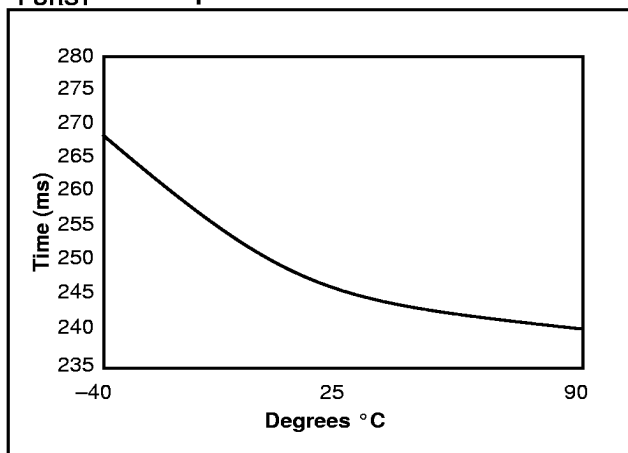
V_{TRIP} vs. Temperature (programmed at 25°C)



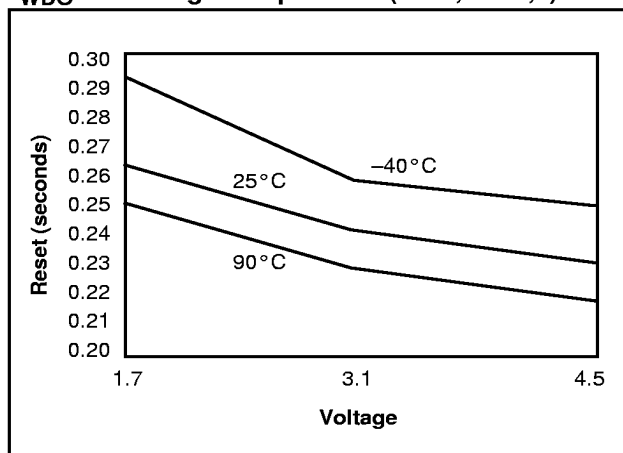
t_{WDO} vs. Voltage/Temperature (WD1,0=1,0)



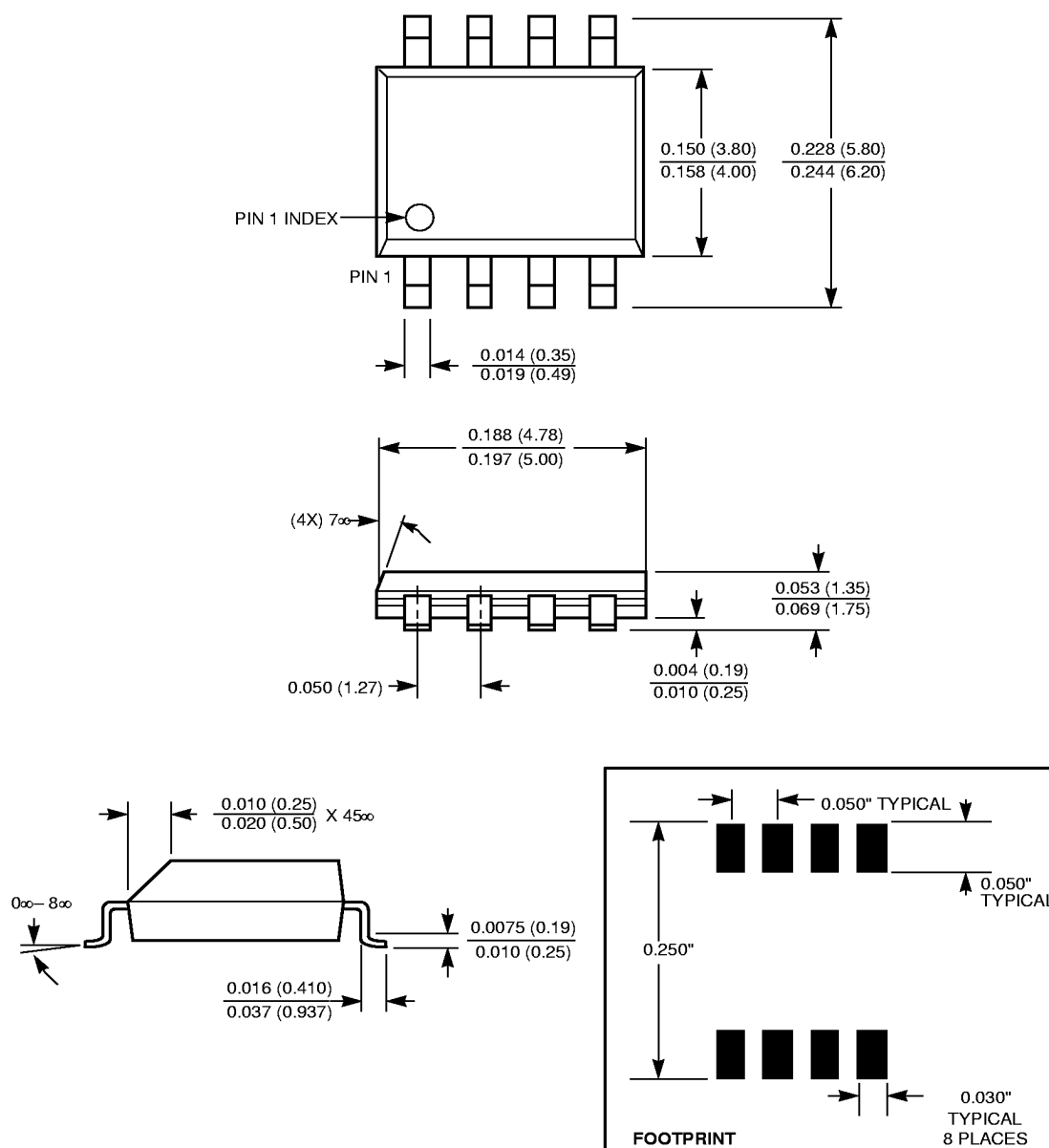
t_{PURST} vs. Temperature



t_{WDO} vs. Voltage/Temperature (WD1,0 0=0,1)

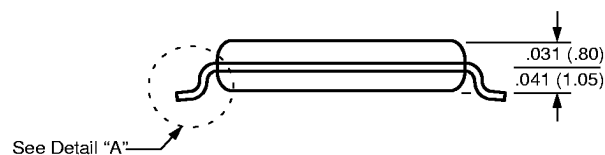
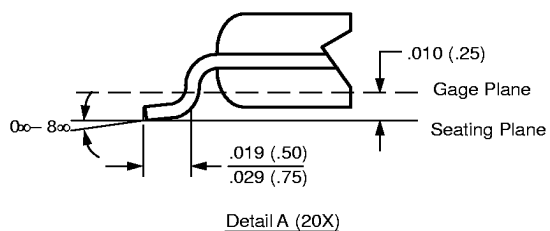
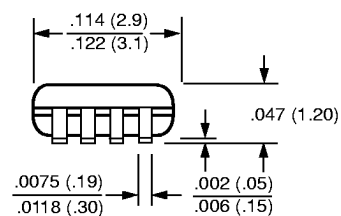
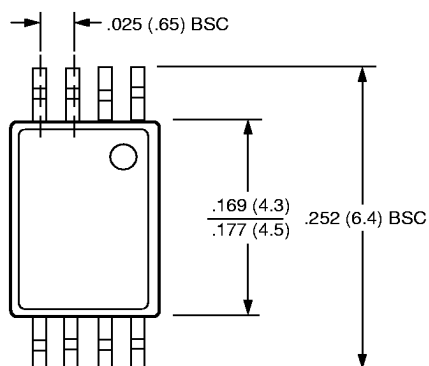


8-LEAD PLASTIC SMALL OUTLINE GULL WING PACKAGE TYPE S



NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

8-LEAD PLASTIC, TSSOP, PACKAGE TYPE V



NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

X5001

Ordering Information

Vcc Range	Vtrip Range	Package	Operating Temperature Range	PART NUMBER RESET (Active LOW)
4.5-5.5V	4.5.4.75	8 pin PDIP	0°C - 70°C	X5001P-4.5A
		8L SOIC	0°C - 70°C	X5001S8-4.5A
		8L TSSOP	0°C - 70°C	X5001V8-4.5A
4.5-5.5V	4.25.4.5	8 pin PDIP	0°C - 70°C	X5001P
		8L SOIC	0°C - 70°C	X5001S8
		8L TSSOP	0°C - 70°C	X5001V8
2.7-5.5V	2.85-3.0	8L SOIC	0°C - 70°C	X5001S8-2.7A
2.7-5.5V	2.55-2.7	8L SOIC	0°C - 70°C	X5001S8-2.7
		8L TSSOP	0°C - 70°C	X5001V8-2.7
1.8-3.6V	1.7-1.8	8L SOIC	0°C - 70°C	X5001S8-1.8
		8L TSSOP	0°C - 70°C	X5001V8-1.8

X5001

Part Mark Information

8-Lead TSSOP

YWW
XXXXX

501AG = 1.8 to 3.6V, 0 to +70°C, V_{TRIP} =1.7-1.8V
501AH = 1.8 to 3.6V, -40 to +85°C, V_{TRIP} =1.7-1.8V
5001F = 2.7 to 5.5V, 0 to +70°C, V_{TRIP} =2.55-2.7V
5001G = 2.7 to 5.5V, -40 to +85°C, V_{TRIP} =2.55-2.7V
501AN = 2.7 to 5.5V, 0 to +70°C, V_{TRIP} =2.85-3.0V
501AP = 2.7 to 5.5V, -40 to +85°C, V_{TRIP} =2.85-3.0V
X5001 = 4.5 to 5.5V, 0 to +70°C, V_{TRIP} =4.25-4.5V
5001I = 4.5 to 5.5V, -40 to +85°C, V_{TRIP} =4.25-4.5V
501AL = 4.5 to 5.5V, 0 to +70°C, V_{TRIP} =4.5-4.75V
501AM = 4.5 to 5.5V, -40 to +85°C, V_{TRIP} =4.5-4.75V

8-Lead SOIC

X5001
YWW XX

AG = 1.8 to 3.6V, 0 to +70°C, V_{TRIP} =1.7-1.8V
AH = 1.8 to 3.6V, -40 to +85°C, V_{TRIP} =1.7-1.8V
F = 2.7 to 5.5V, 0 to +70°C, V_{TRIP} =2.55-2.7V
G = 2.7 to 5.5V, -40 to +85°C, V_{TRIP} =2.55-2.7V
AN = 2.7 to 5.5V, 0 to +70°C, V_{TRIP} =2.85-3.0V
AP = 2.7 to 5.5V, -40 to +85°C, V_{TRIP} =2.85-3.0V
Blank = 4.5 to 5.5V, 0 to +70°C, V_{TRIP} =4.25-4.5V
I = 4.5 to 5.5V, -40 to +85°C, V_{TRIP} =4.25-4.5V
AL = 4.5 to 5.5V, 0 to +70°C, V_{TRIP} =4.5-4.75V
AM = 4.5 to 5.5V, -40 to +85°C, V_{TRIP} =4.5-4.75V

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.